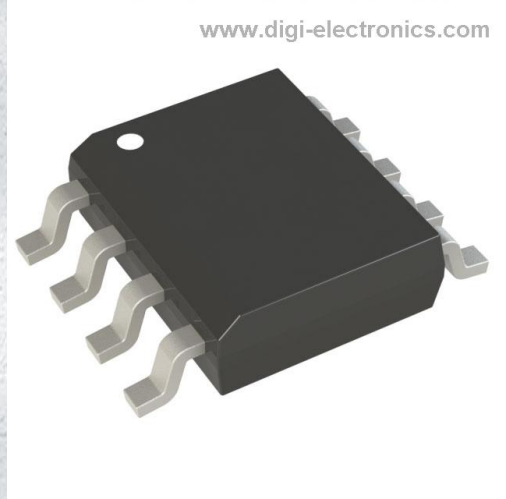
DG417BDY-T1 Datasheet



https://www.DiGi-Electronics.com

DiGi Electronics Part Number	DG417BDY-T1-DG
Manufacturer	Vishay Siliconix
Manufacturer Product Number	DG417BDY-T1
Description	IC SWITCH SPST-NCX1 25OHM 8SOIC
Detailed Description	1 Circuit IC Switch 1:1 25Ohm 8-SOIC

Tel: +00 852-30501935

RFQ Email: Info@DiGi-Electronics.com

Purchase and inquiry

Manufacturer Product Number:	Manufacturer:
DG417BDY-T1	Vishay Siliconix
Series:	Product Status:
-	Obsolete
Switch Circuit:	Multiplexer/Demultiplexer Circuit:
SPST - NC	1:1
Number of Circuits:	On-State Resistance (Max):
1	25Ohm
Channel-to-Channel Matching (ΔRon):	Voltage - Supply, Single (V+):
-	13V ~ 36V
Voltage - Supply, Dual (V±):	Switch Time (Ton, Toff) (Max):
±7V ~ 22V	89ns, 80ns
-3db Bandwidth:	Charge Injection:
-	38pC
Channel Capacitance (CS(off), CD(off)):	Current - Leakage (IS(off)) (Max):
12pF, 12pF	250pA
Crosstalk:	Operating Temperature:
-	-40°C ~ 85°C (TA)
Mounting Type:	Package / Case:
Surface Mount	8-SOIC (0.154", 3.90mm Width)
Supplier Device Package:	Base Product Number:
8-SOIC	DG417

Environmental & Export classification

RoHS Status:	Moisture Sensitivity Level (MSL):
RoHS non-compliant	1 (Unlimited)
REACH Status:	ECCN:
REACH Unaffected	EAR99
HTSUS:	
8542.39.0001	

DG417B, DG418B, DG419B

Vishay Siliconix

Precision Monolithic Quad SPST CMOS Analog Switches

DESCRIPTION

The DG417B, DG418B, DG419B monolithic CMOS analog switches were designed to provide high performance switching of analog signals. Combining low power, low leakages, high speed, low on-resistance and small physical size, the DG417B series is ideally suited for portable and battery powered industrial and military applications requiring high performance and efficient use of board space.

To achieve high-voltage ratings and superior switching performance, the DG417B series is built on Vishay Siliconix's high voltage silicon gate (HVSG) process. Break-before-make is guaranteed for the DG419B, which is an SPDT configuration. An epitaxial layer prevents latchup.

Each switch conducts equally well in both directions when on, and blocks up to the power supply level when off.

The DG417B and DG418B respond to opposite control logic levels as shown in the Truth Table.

FEATURES

- ± 15 V analog signal range
- On-resistance - $R_{DS(on)}$: 15 Ω
- Fast switching action - t_{ON}: 110 ns
- TTL and CMOS compatible
- MSOP-8 and SOIC-8 package
- Compliant to RoHS directive 2002/95/EC

Pb-free Available

RoHS* COMPLIANT

BENEFITS

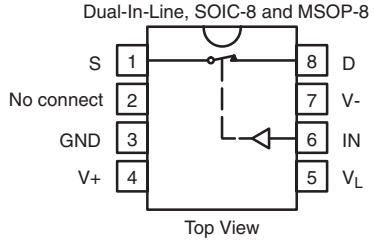
- Widest dynamic range
- Low signal errors and distortion
- Break-before-make switching action
- Simple interfacing
- Reduced board space
- Improved reliability

APPLICATIONS

- Precision test equipment
- Precision instrumentation
- Battery powered systems
- Sample-and-hold circuits
- Military radios
- Guidance and control systems
- Hard disk drivers

FUNCTIONAL BLOCK DIAGRAM AND PIN CONFIGURATION

DG417B
Dual-In-Line, SOIC-8 and MSOP-8

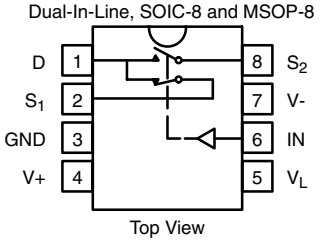


Top View

TRUTH TABLE		
Logic	DG417B	DG418B
0	ON	OFF
1	OFF	ON

Logic "0" ≤ 0.8 V
Logic "1" ≥ 2.4 V

DG419B
Dual-In-Line, SOIC-8 and MSOP-8



Top View

TRUTH TABLE - DG419B		
Logic	SW_1	SW_2
0	ON	OFF
1	OFF	ON

Logic "0" ≤ 0.8 V
Logic "1" ≥ 2.4 V

* Pb containing terminations are not RoHS compliant, exemptions may apply

DG417B, DG418B, DG419B

Vishay Siliconix

ORDERING INFORMATION

Temp Range	Package	Part Number
DG417B, DG418B		
- 40 °C to 85 °C	8-Pin Plastic MiniDIP	DG417BDJ DG417BDJ-E3
		DG418BDJ DG418BDJ-E3
	8-Pin Narrow SOIC	DG417BDY DG417BDY-E3 DG417BDY-T1 DG417BDY-T1-E3
		DG418BDY DG418BDY-E3 DG418BDY-T1 DG418BDY-T1-E3
	8-Pin MSOP	DG417BDQ-T1-E3
		DG418BDQ-T1-E3
DG419B		
- 40 °C to 85 °C	8-Pin Plastic MiniDIP	DG419BDJ DG419BDJ-E3
	8-Pin Narrow SOIC	DG419BDY DG419BDY-E3 DG419BDY-T1 DG419BDY-T1-E3
	8-Pin MSOP	DG419BDQ-T1-E3

ABSOLUTE MAXIMUM RATINGS

Parameter		Limit	Unit
V-		- 20	V
V+		20	
GND		25	
V_L		(GND - 0.3) to (V+) + 0.3	
Digital Inputs[a], V_S, V_D		(V-) - 2 V to (V+) + 2 or 30 mA, whichever occurs first	
Current, (Any Terminal) Continuous		30	mA
Current (S or D) Pulsed at 1 ms, 10 % Duty Cycle		100	
Storage Temperature		- 65 to 150	°C
Power Dissipation (Package)[b]	8-Pin Plastic MiniDIP[c]	400	mW
	8-Pin Narrow SOIC[c]	400	
	8-Pin MSOP[d]	400	
	8-Pin CerDIP[e]	600	

Notes:
a. Signals on S_X, D_X, or IN_X exceeding V+ or V- will be clamped by internal diodes. Limit forward diode current to maximum current ratings.
b. All leads welded or soldered to PC board.
c. Derate 5.3 mW/°C above 75 °C.
d. Derate 4 mW/°C above 70 °C.
e. Derate 8 mW/°C above 75 °C.

SCHEMATIC DIAGRAM Typical Channel

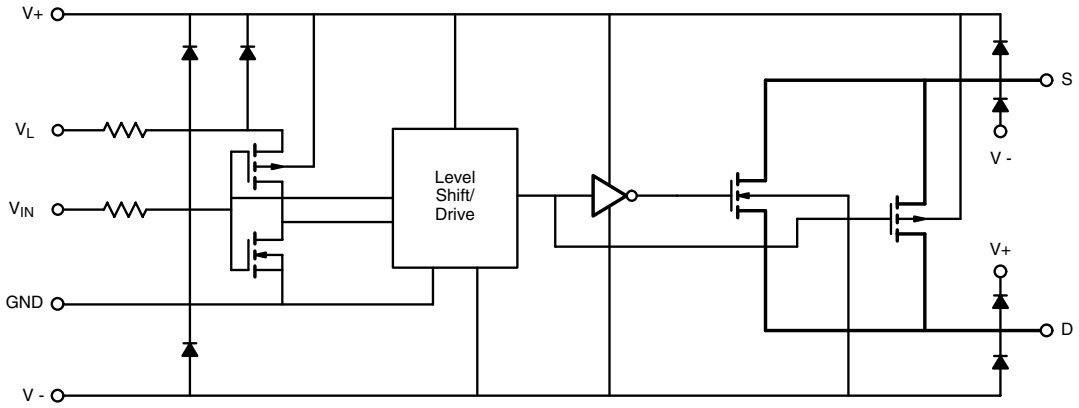


Figure 1.

SPECIFICATIONS[a]

Parameter	Symbol	Test Conditions Unless Otherwise Specified V+ = 15 V, V- = - 15 V V_L = 5 V, V_{IN} = 2.4 V, 0.8 V[f]		Temp.[b]	Typ.[c]	A Suffix - 55 °C to 125 °C Min.[d]	A Suffix - 55 °C to 125 °C Max.[d]	D Suffix - 40 °C to 85 °C Min.[d]	D Suffix - 40 °C to 85 °C Max.[d]	Unit
Analog Switch										
Analog Signal Range[e]	V_{ANALOG}			Full		- 15	15	- 15	15	V
Drain-Source On-Resistance	$R_{DS(on)}$	I_S = - 10 mA, V_D = ± 12.5 V V+ = 13.5 V, V- = - 13.5 V		Room Full	15		25 34		25 29	Ω
Switch Off Leakage Current	$I_{S(off)}$	V+ = 16.5, V- = - 16.5 V V_D = ± 15.5 V, V_S = ± 15.5 V		Room Full	- 0.1	- 0.25 - 20	0.25 20	- 0.25 - 5	0.25 5	nA
	$I_{D(off)}$		DG417B DG418B	Room Full	- 0.1	- 0.25 - 20	0.25 20	- 0.25 - 5	0.25 5	
			DG419B	Room Full	- 0.1	- 0.75 - 60	0.75 60	- 0.75 - 12	0.75 12	
Channel On Leakage Current	$I_{D(on)}$	V+ = 16.5 V, V- = - 16.5 V V_S = V_D = ± 15.5 V	DG417B DG418B	Room Full	- 0.4	- 0.4 - 40	0.4 40	- 0.4 - 10	0.4 10	
			DG419B	Room Full	- 0.4	- 0.75 - 60	0.75 60	- 0.75 - 12	0.75 12	
Digital Control										
Input Current, V_{IN} Low	I_{IL}			Full		- 0.5	0.5	- 0.5	0.5	µA
Input Current, V_{IN} High	I_{IH}			Full		- 0.5	0.5	- 0.5	0.5	
Dynamic Characteristics										
Turn-On Time	t_{ON}	R_L = 300 Ω, C_L = 35 pF V_S = ± 10 V, See Switching Time Test Circuit	DG417B DG418B	Room Full	62		89 106		89 99	ns
Turn-Off Time	t_{OFF}		DG417B DG418B	Room Full	53		80 88		80 86	
Transition Time	t_{TRANS}	R_L = 300 Ω, C_L = 35 pF V_{S1} = ± 10 V, V_{S2} = ± 10 V	DG419B	Room Full	60		87 96		87 93	
Break-Before-Make Time Delay	t_D	R_L = 300 Ω, C_L = 35 pF V_{S1} = V_{S2} = ± 10 V	DG419B	Room	16	3		3		
Charge Injection	Q	C_L = 10 nF V_{gen} = 0 V, R_{gen} = 0 Ω		Room	38					pC
Off Isolation[e]	OIRR	R_L = 50 Ω, C_L = 5 pF, f = 1 MHz		Room	- 82					dB
Channel-to-Channel Crosstalk[e]	X_{TALK}		DG419B	Room	- 88					

DG417B, DG418B, DG419B

Vishay Siliconix

SPECIFICATIONS[a]

Parameter	Symbol	Test Conditions Unless Otherwise Specified V+ = 15 V, V- = - 15 V V_L = 5 V, V_{IN} = 2.4 V, 0.8 V[f]		Temp.[b]	Typ.[c]	A Suffix - 55 °C to 125 °C Min.[d]	A Suffix - 55 °C to 125 °C Max.[d]	D Suffix - 40 °C to 85 °C Min.[d]	D Suffix - 40 °C to 85 °C Max.[d]	Unit
Dynamic Characteristics										
Source Off Capacitance[e]	$C_{S(off)}$	f = 1 MHz, V_S = 0 V		Room	12					pF
Drain Off Capacitance[e]	$C_{D(off)}$	f = 1 MHz, V_S = 0 V	DG417B DG418B	Room	12					pF
Channel On Capacitance[e]	$C_{D(on)}$	f = 1 MHz, V_S = 0 V	DG417B DG418B	Room	50					pF
			DG419B	Room	57					pF
Power Supplies										
Positive Supply Current	I+	V+ = 16.5 V, V- = - 16.5 V V_{IN} = 0 or 5 V		Room Full	0.001		1 5		1 5	µA
Negative Supply Current	I-			Room Full	- 0.001	- 1 - 5		- 1 - 5		µA
Logic Supply Current	I_L			Room Full	0.001		1 5		1 5	µA
Ground Current	I_{GND}			Room Full	- 0.001	- 1 - 5		- 1 - 5		µA

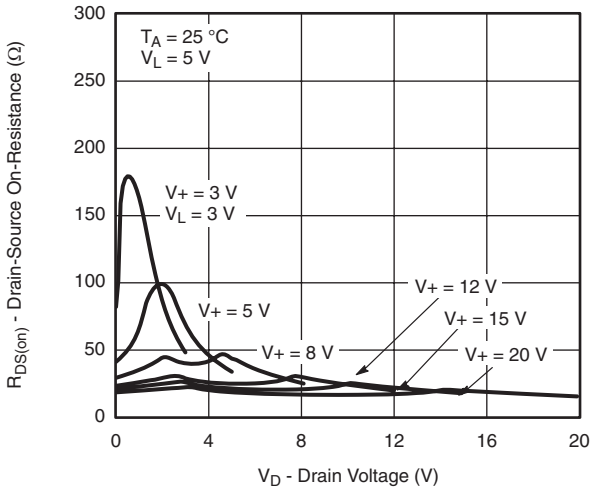
SPECIFICATIONS[a]

Parameter	Symbol	Test Conditions Unless Otherwise Specified V+ = 12 V, V- = 0 V V_L = 5 V, V_{IN} = 2.4 V, 0.8 V[f]		Temp.[b]	Typ.[c]	A Suffix - 55 °C to 125 °C Min.[d]	A Suffix - 55 °C to 125 °C Max.[d]	D Suffix - 40 °C to 85 °C Min.[d]	D Suffix - 40 °C to 85 °C Max.[d]	Unit
Analog Switch										
Analog Signal Range[e]	V_{ANALOG}			Full		0	12	0	12	V
Drain-Source On-Resistance	$R_{DS(on)}$	I_S = - 10 mA, V_D = 3.8 V V+ = 10.8 V		Room Full	26		35 52		35 45	Ω
Dynamic Characteristics										
Turn-On Time	t_{ON}	R_L = 300 Ω, C_L = 35 pF V_S = 8 V, See Switching Time Test Circuit		Room Full	100		125 155		125 143	ns
Turn-Off Time	t_{OFF}			Room Full	38		66 73		66 69	ns
Break-Before-Make Time Delay	t_D	R_L = 300 Ω, C_L = 35 pF	DG419B	Room	62	25		25		ns
Transition Time	t_{TRANS}	R_L = 300 Ω, C_L = 35 pF V_{S1} = 0 V, 8 V, V_{S2} = 8 V, 0 V		Room Full	95		119 153		119 141	ns
Charge Injection	Q	C_L = 10 nF, V_{gen} = 0 V, R_{gen} = 0 Ω		Room	18					pC
Power Supplies										
Positive Supply Current	I+	V+ = 13.2 V, V_L = 5.25 V V_{IN} = 0 or 5 V		Room Full	0.001		1 5		1 5	µA
Negative Supply Current	I-			Room	- 0.001	- 1 - 5		- 1 - 5		µA
Logic Supply Current	I_L			Room	0.001		1 5		1 5	µA
Ground Current	I_{GND}			Room	- 0.001	- 1 - 5		-1 - 5		µA

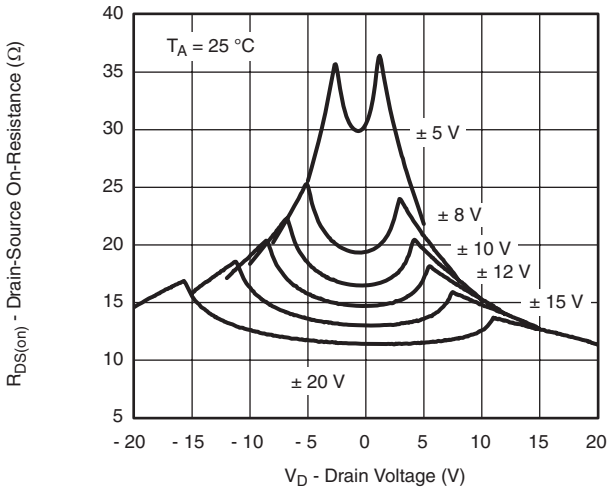
Notes:
a. Refer to PROCESS OPTION FLOWCHART.
b. Room = 25 °C, full = as determined by the operating temperature suffix.
c. Typical values are for DESIGN AID ONLY, not guaranteed nor subject to production testing.
d. The algebraic convention whereby the most negative value is a minimum and the most positive a maximum, is used in this datasheet.
e. Guaranteed by design, not subject to production test.
f. V_{IN} = input voltage to perform proper function.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

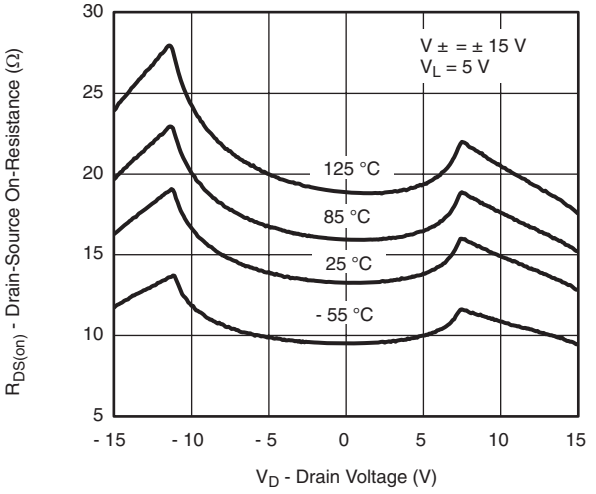
TYPICAL CHARACTERISTICS T_A = 25 °C, unless otherwise noted



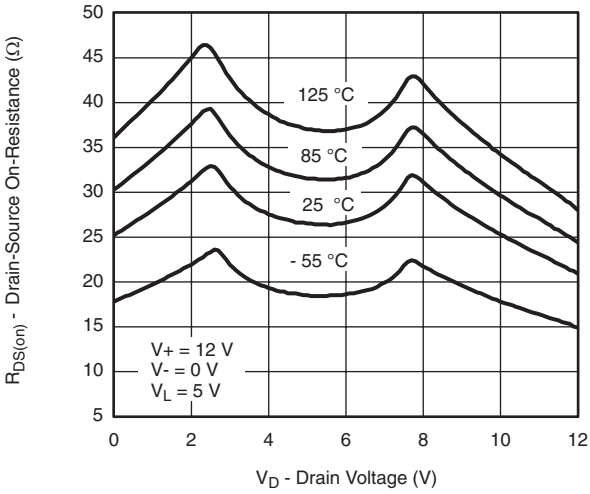
On-Resistance vs. V_D and Unipolar Power Supply Voltage



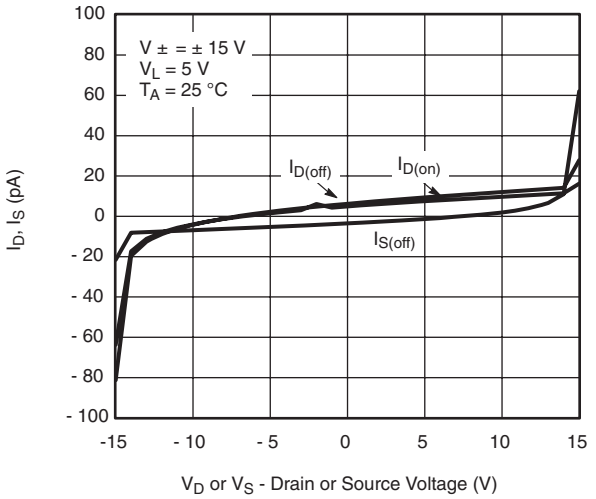
On-Resistance vs. V_D and Dual Supply Voltage



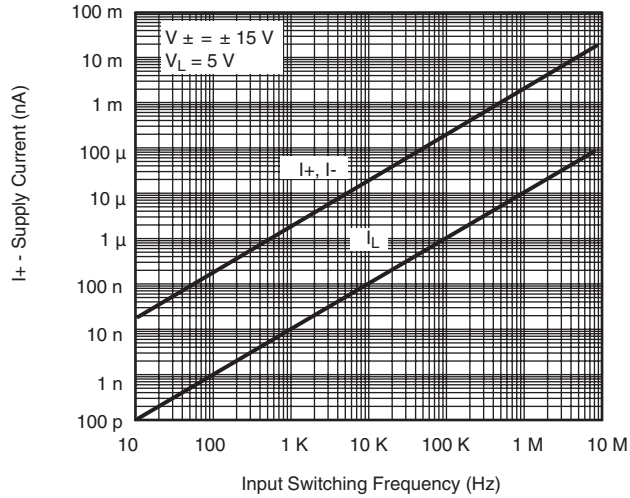
On-Resistance vs. V_D and Temperature



On-Resistance vs. V_D and Temperature

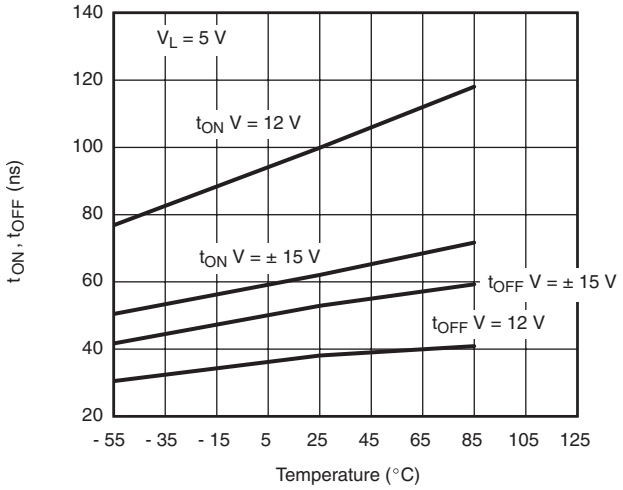


Leakage vs. Analog Voltage

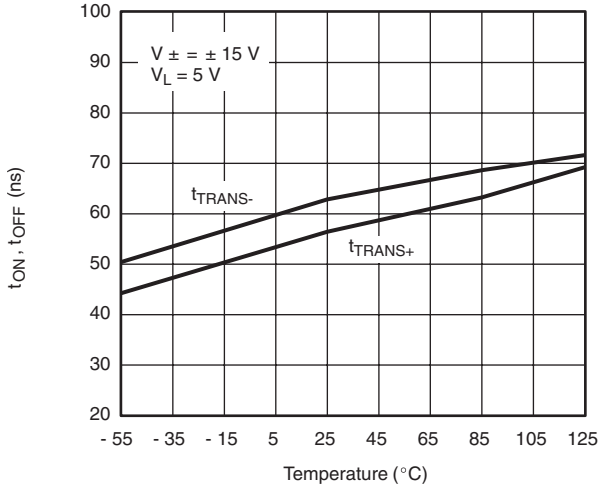


Supply Current vs. Input Switching Frequency

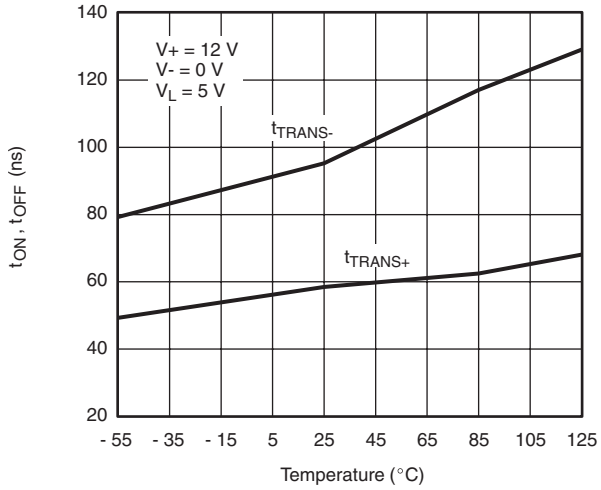
TYPICAL CHARACTERISTICS T_A = 25 °C, unless otherwise noted



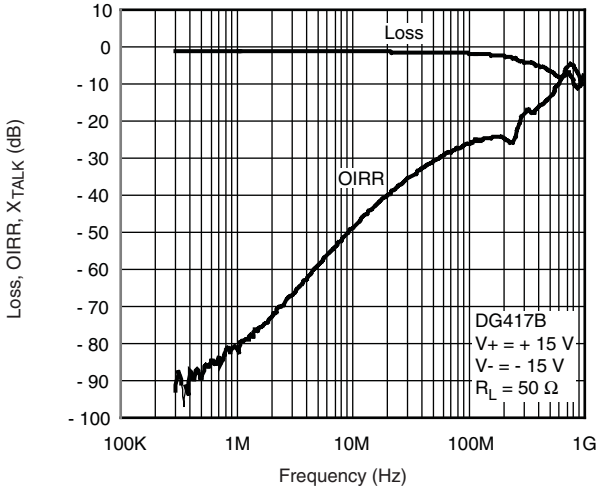
Switching Time vs. Temperature



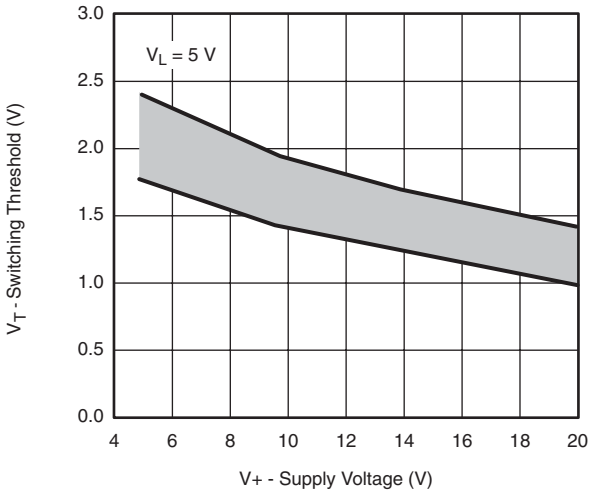
Transition Time vs. Temperature



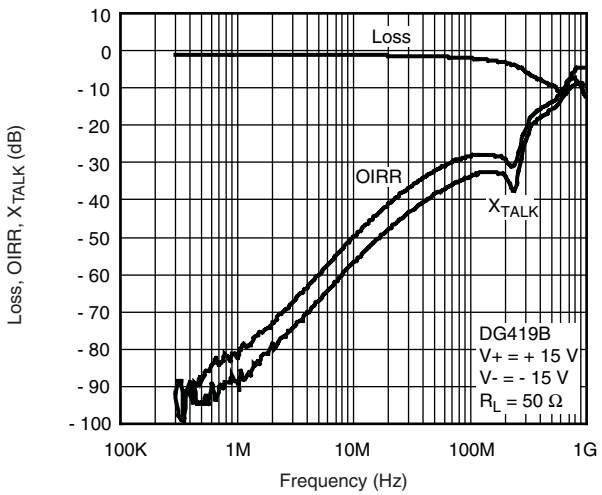
Transition Time vs. Temperature



Insertion Loss, Off -Isolation Crosstalk vs. Frequency

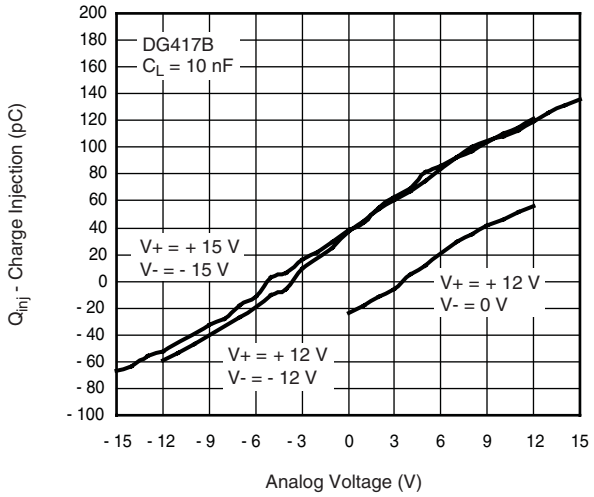


Switching Threshold vs. Supply Voltage

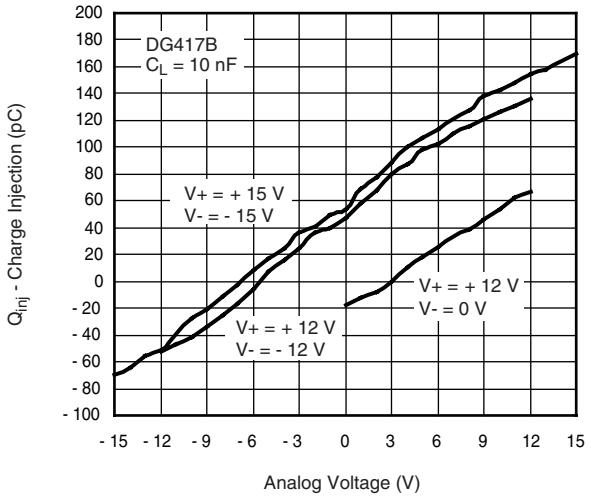


Insertion Loss, Off -Isolation Crosstalk vs. Frequency

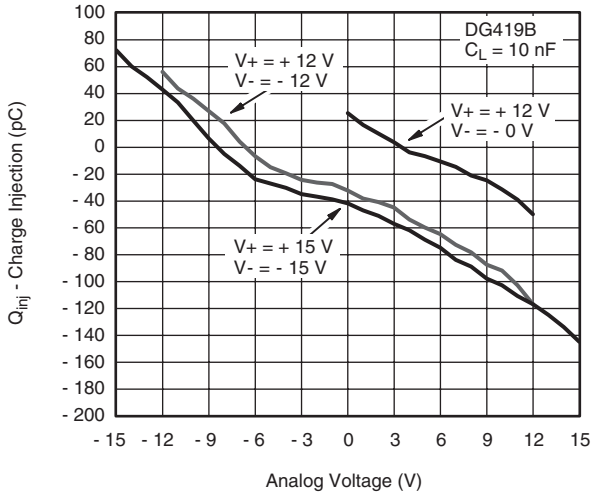
TYPICAL CHARACTERISTICS T_A = 25 °C, unless otherwise noted



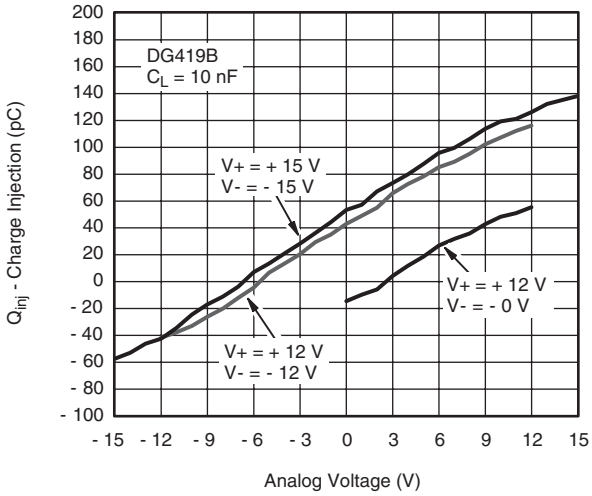
Charge Injection vs. Analog Voltage (Measured at drain pin)



Charge Injection vs. Analog Voltage (Measured at source pin)



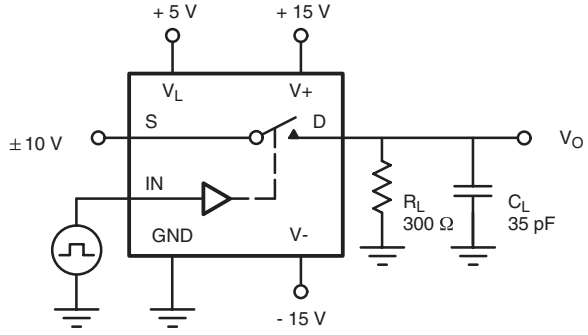
Charge Injection vs. Analog Voltage (Measured at drain pin)



Charge Injection vs. Analog Voltage (Measured at source pin)

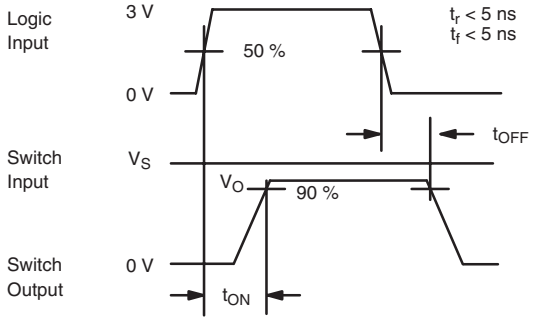
TEST CIRCUITS

V_O is the steady state output with the switch on.



C_L (includes fixture and stray capacitance)

$$V_O = V_S \frac{R_L}{R_L + R_{DS(on)}}$$



Note: Logic input waveform is inverted for switches that have the opposite logic sense.

Figure 2. Switching Time (DG417B/418B)

TEST CIRCUITS

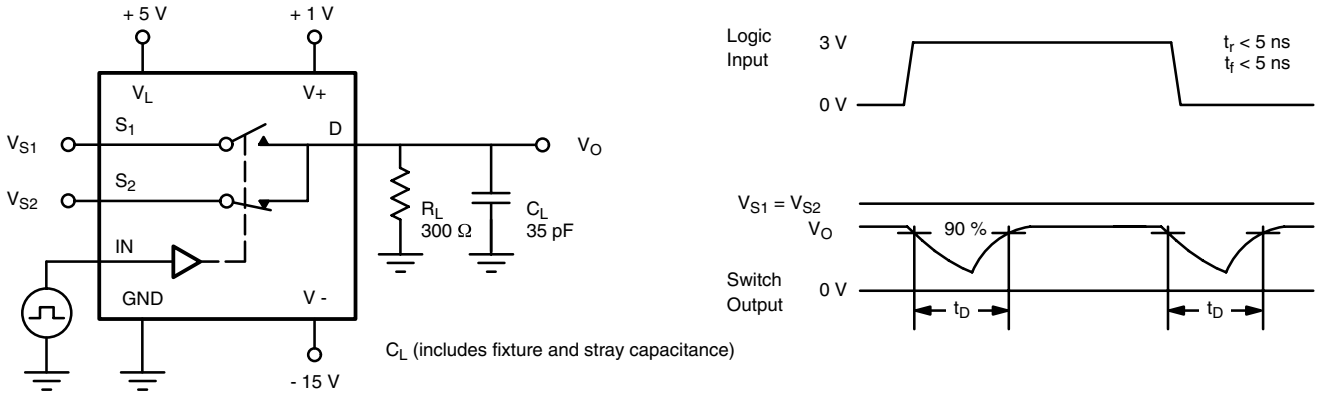
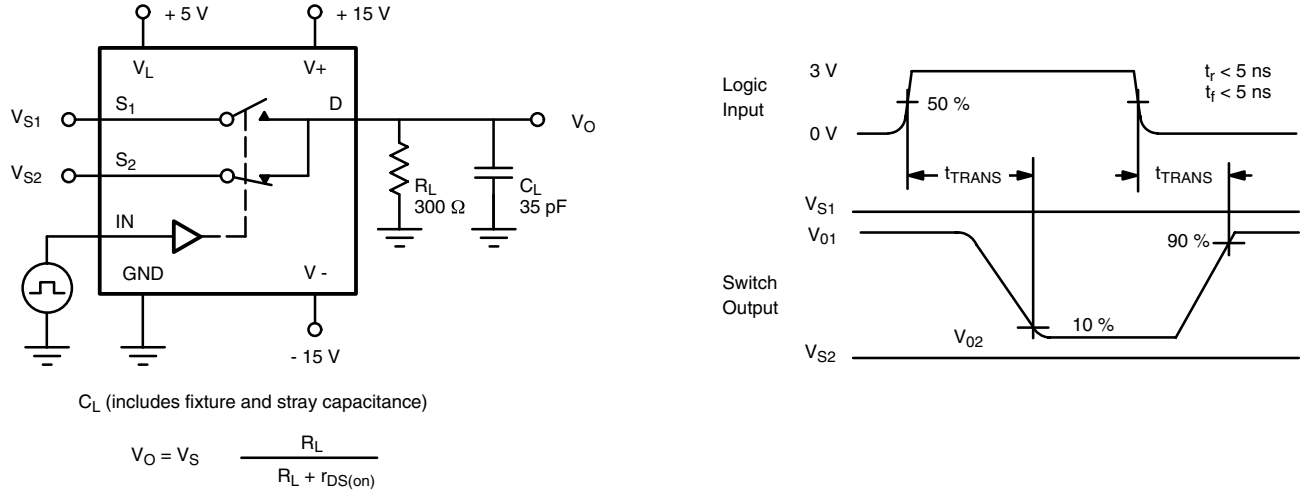


Figure 3. Break-Before-Make (DG419B)



$$V_O = V_S \frac{R_L}{R_L + r_{DS(on)}}$$

Figure 4. Transition Time (DG419B)

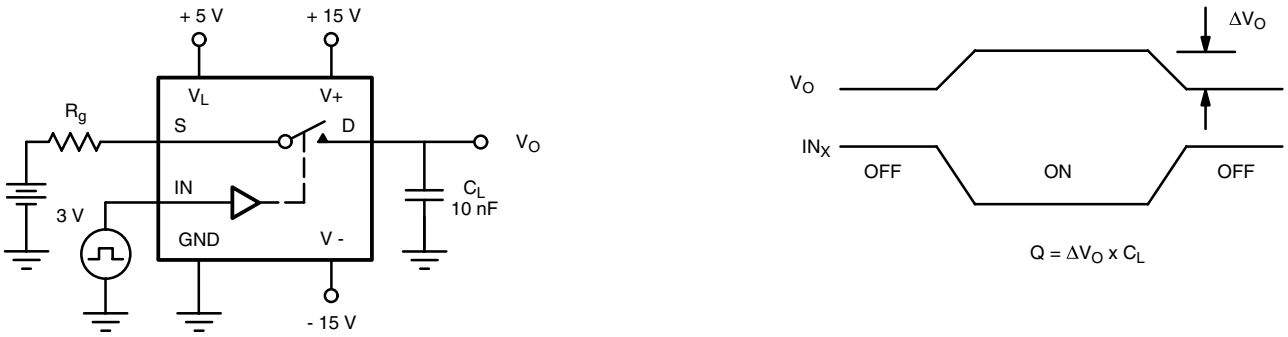


Figure 5. Charge Injection

TEST CIRCUITS

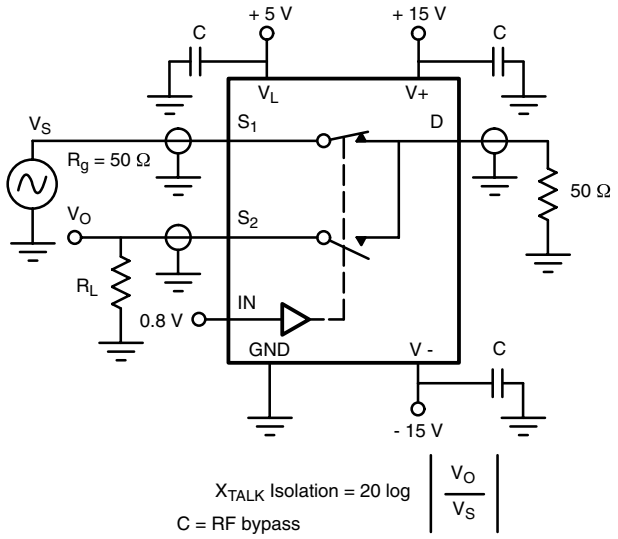


Figure 6. Crosstalk

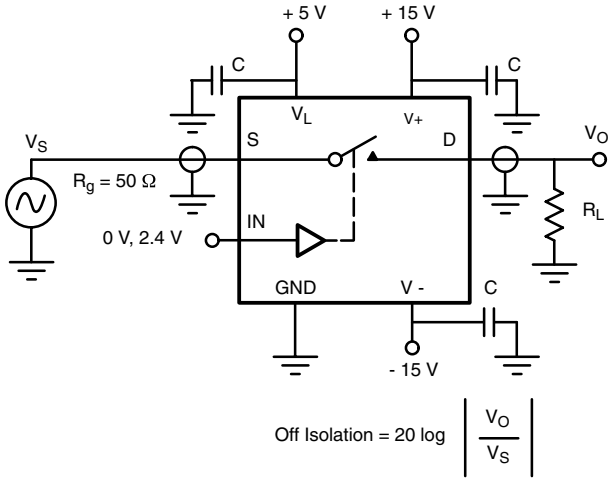


Figure 7. Off isolation

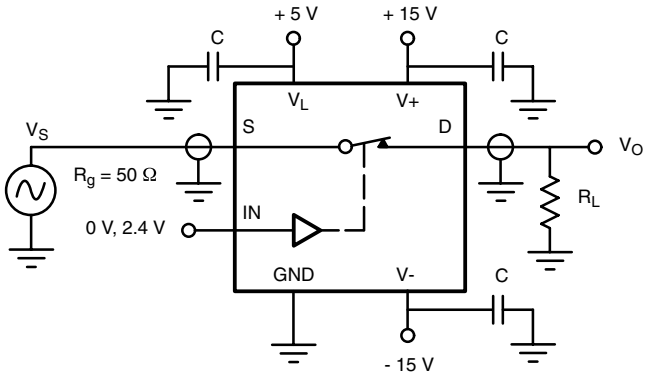


Figure 8. Insertion Loss

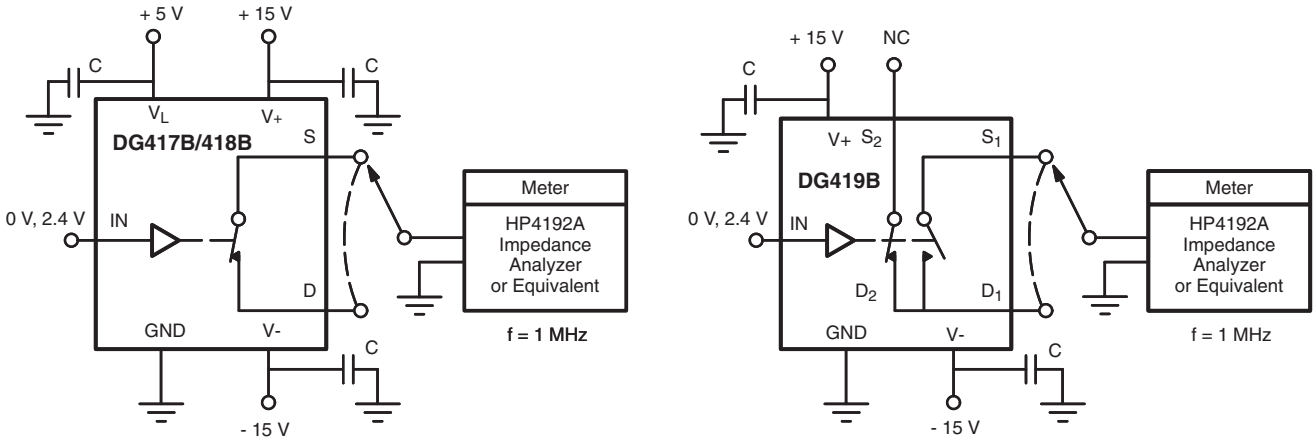


Figure 9. Source/Drain Capacitances

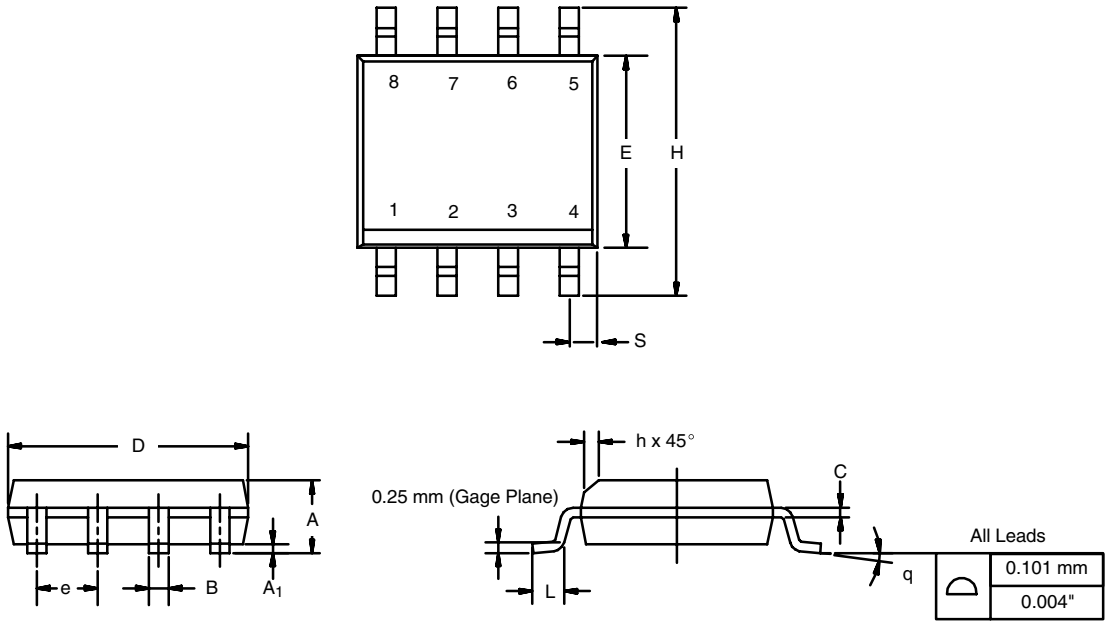
Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?72107.

Package Information

Vishay Siliconix

SOIC (NARROW): 8-LEAD

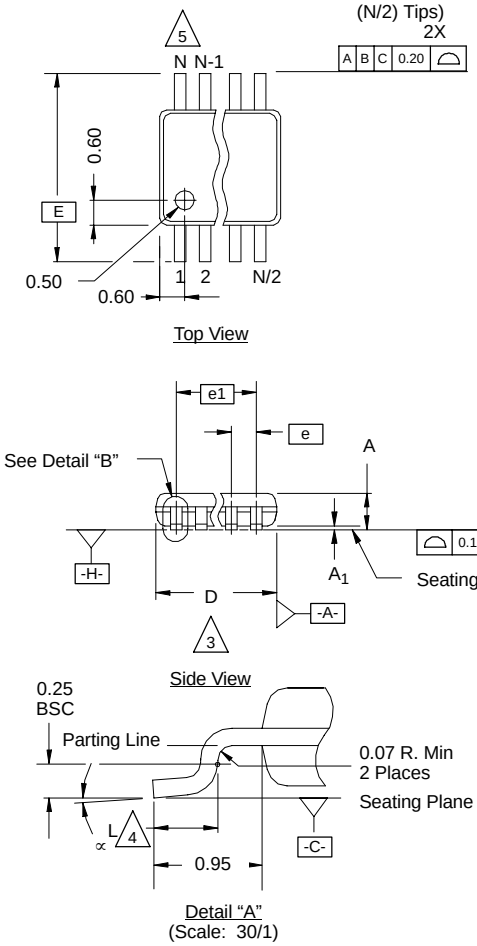
JEDEC Part Number: MS-012

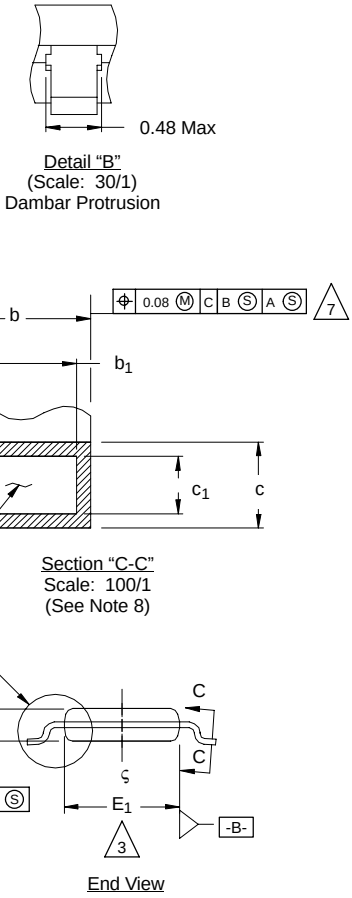


DIM	MILLIMETERS		INCHES	
	Min	Max	Min	Max
A	1.35	1.75	0.053	0.069
A_1	0.10	0.20	0.004	0.008
B	0.35	0.51	0.014	0.020
C	0.19	0.25	0.0075	0.010
D	4.80	5.00	0.189	0.196
E	3.80	4.00	0.150	0.157
e	1.27 BSC		0.050 BSC	
H	5.80	6.20	0.228	0.244
h	0.25	0.50	0.010	0.020
L	0.50	0.93	0.020	0.037
q	0°	8°	0°	8°
S	0.44	0.64	0.018	0.026
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498				

Package Information
Vishay Siliconix

MSOP: 8-LEADS
JEDEC Part Number: MO-187, (Variation AA and BA)





NOTES:

1. Die thickness allowable is 0.203 ± 0.0127.
2. Dimensioning and tolerances per ANSI.Y14.5M-1994.
3. Dimensions "D" and "E_1" do not include mold flash or protrusions, and are measured at Datum plane -H- , mold flash or protrusions shall not exceed 0.15 mm per side.
4. Dimension is the length of terminal for soldering to a substrate.
5. Terminal positions are shown for reference only.
6. Formed leads shall be planar with respect to one another within 0.10 mm at seating plane.
7. The lead width dimension does not include Dambar protrusion. Allowable Dambar protrusion shall be 0.08 mm total in excess of the lead width dimension at maximum material condition. Dambar cannot be located on the lower radius or the lead foot. Minimum space between protrusions and an adjacent lead to be 0.14 mm. See detail "B" and Section "C-C".
8. Section "C-C" to be determined at 0.10 mm to 0.25 mm from the lead tip.
9. Controlling dimension: millimeters.
10. This part is compliant with JEDEC registration MO-187, variation AA and BA.
11. Datums -A- and -B- to be determined Datum plane -H- .
12. Exposed pad area in bottom side is the same as teh leadframe pad size.

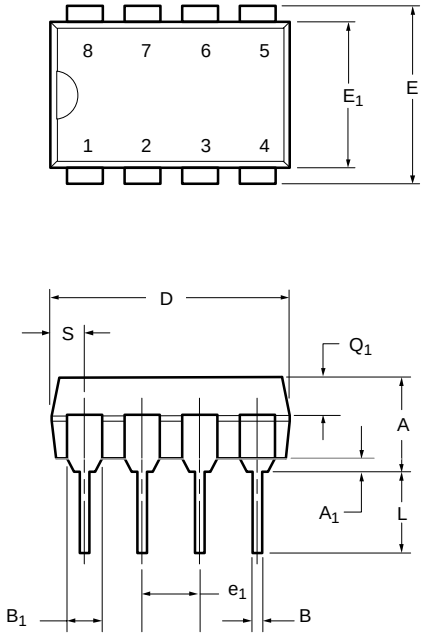
N = 8L

Dim	MILLIMETERS			Note
	Min	Nom	Max	
A	-	-	1.10	
A_1	0.05	0.10	0.15	
A_2	0.75	0.85	0.95	
b	0.25	-	0.38	8
b_1	0.25	0.30	0.33	8
c	0.13	-	0.23	
c_1	0.13	0.15	0.18	
D	3.00 BSC			3
E	4.90 BSC			
E_1	2.90	3.00	3.10	3
e	0.65 BSC			
e_1	1.95 BSC			
L	0.40	0.55	0.70	4
N	8			5
∝	0°	4°	6°	

ECN: T-02080—Rev. C, 15-Jul-02
DWG: 5867

Package Information
Vishay Siliconix

PDIP: 8-LEAD



Dim	MILLIMETERS		INCHES	
	Min	Max	Min	Max
A	3.81	5.08	0.150	0.200
A_1	0.38	1.27	0.015	0.050
B	0.38	0.51	0.015	0.020
B_1	0.89	1.65	0.035	0.065
C	0.20	0.30	0.008	0.012
D	9.02	10.92	0.355	0.430
E	7.62	8.26	0.300	0.325
E_1	5.59	7.11	0.220	0.280
e_1	2.29	2.79	0.090	0.110
e_A	7.37	7.87	0.290	0.310
L	2.79	3.81	0.110	0.150
Q_1	1.27	2.03	0.050	0.080
S	0.76	1.65	0.030	0.065

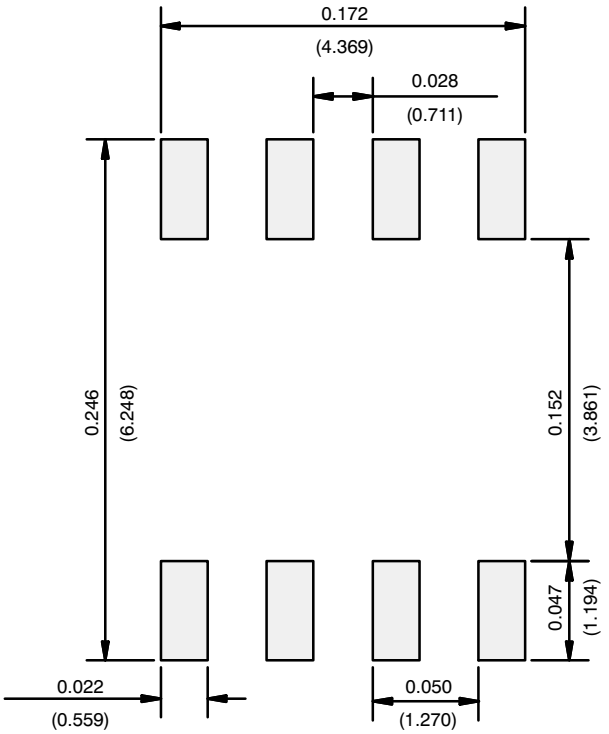
ECN: S-03946—Rev. E, 09-Jul-01
DWG: 5478

NOTE: End leads may be half leads.

Application Note 826

Vishay Siliconix

RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads
Dimensions in Inches/(mm)

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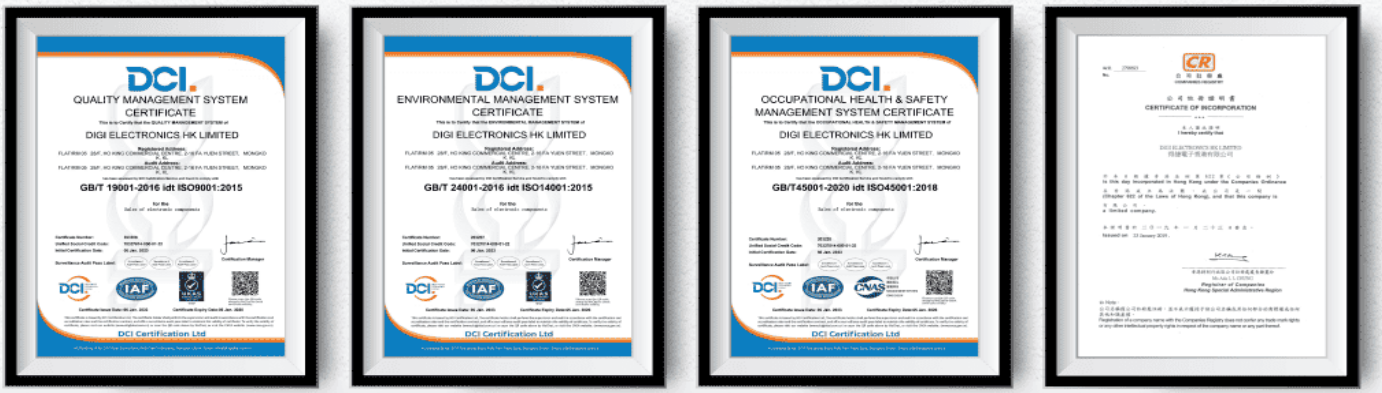

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